

March 2025 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note: All data is based on three month average numbers.

Mark your calendars. **The April Report SEAJ's Web site update** is scheduled on 23rd **May** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts March 2025 Billings of ¥432,401 million Tokyo Japan, April 24th, 2025 JAPAN-based manufacturers of semiconductor equipment posted ¥432,401 million in billings in March 2025(three-month average basis) published today by SEAJ.

The billings figure is **4.9% percent up** the final February 2025 level of ¥412,065 million and **18.2 percent up** the 2024 March billings level of ¥365,680 million.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
October 2024	385,676	4.4%	33.4%
November 2024	405,788	5.2%	35.2%
December 2024	443,364	9.3%	44.7%
January 2025	416,790	-6.0%	32.4%
February 2025(final)	412,065	-1.1%	29.8%
March 2025(prelim)	432,401	4.9%	18.2%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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